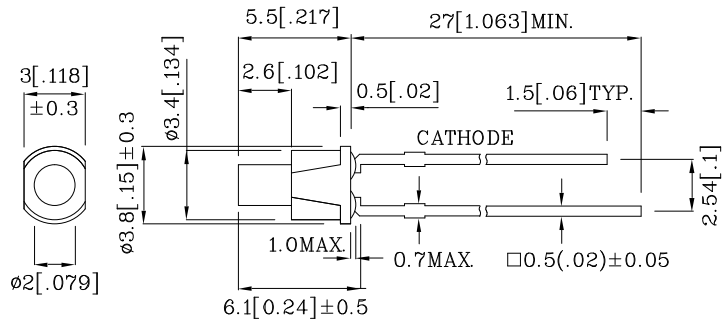


Features

- LOW POWER CONSUMPTION.
- SUITABLE FOR AUDIO PANEL INDICATOR.
- FIT 2mm HOLE IN PANELS.
- LONG LIFE-SOLID STATE RELIABILITY.
- RoHS COMPLIANT.



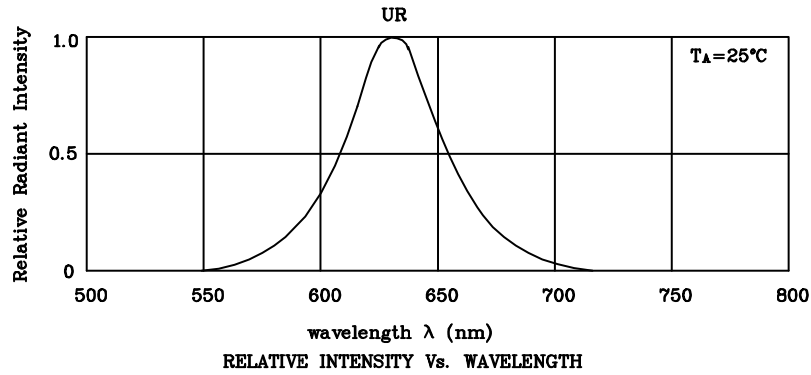
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25(0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

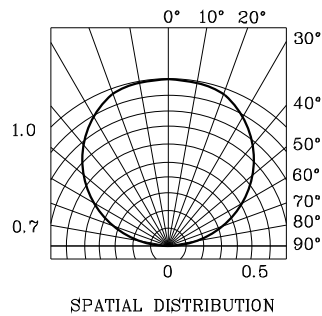
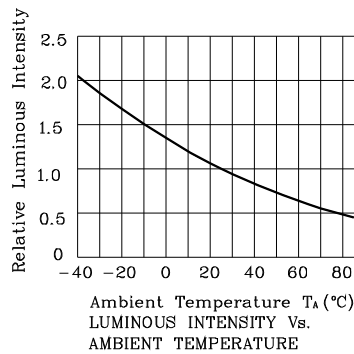
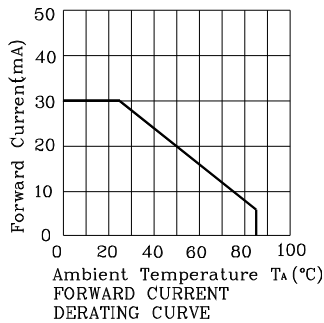
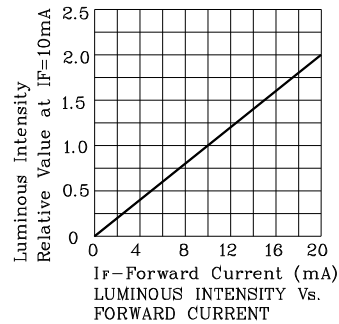
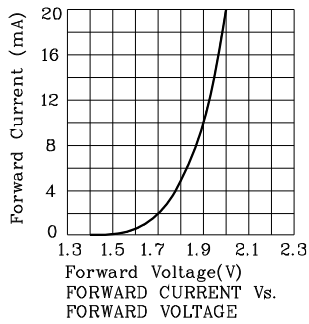
| Absolute Maximum Ratings (TA=25°C) | | UR (GaAsP/GaP) | Unit |
|--|---------------------|-------------------|------|
| Reverse Voltage | VR | 5 | V |
| Forward Current | IF | 30 | mA |
| Forward Current (peak) 1/10 Duty Cycle 0.1ms Pulse Width | iFS | 160 | mA |
| Power Dissipation | PT | 75 | mW |
| Operating Temperature | TA | -40 ~ +85 | °C |
| Storage Temperature | Tstg | -40 ~ +85 | |
| Lead Solder Temperature [2mm below package base] | 260°C For 3 Seconds | | |
| Lead Solder Temperature [5mm below package base] | 260°C For 5 Seconds | | |

| Operating Characteristics (TA=25°C) | | UR (GaAsP/GaP) | Unit |
|---|-----|-------------------|------|
| Forward Voltage (Typ.) (IF=10mA) | VF | 1.9 | V |
| Forward Voltage (Max.) (IF=10mA) | VF | 2.5 | V |
| Reverse Current(Max.) (VR=5V) | IR | 10 | uA |
| Wavelength of Peak Emission (Typ.) (IF=10mA) | λ P | 627 | nm |
| Wavelength of Dominant Emission (Typ.) (IF=10mA) | λ D | 625 | nm |
| Spectral Line Full Width At Half-Maximum (Typ.) (IF=10mA) | Δλ | 45 | nm |
| Capacitance (Typ.) (VF=0V, f=1MHz) | C | 15 | pF |

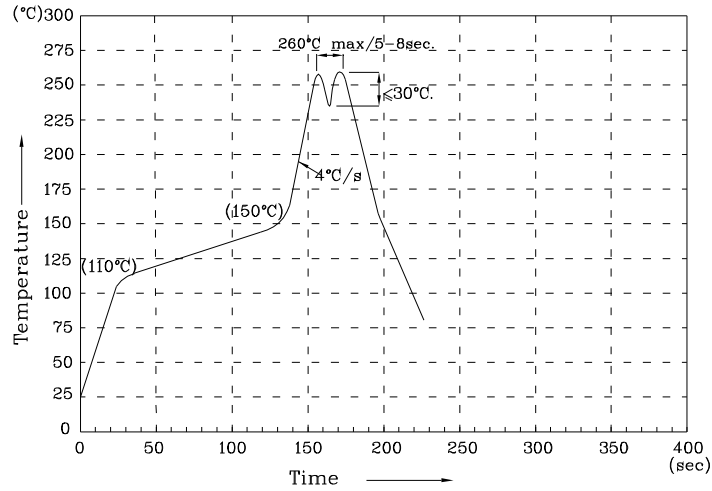
| Part Number | Emitting Color | Emitting Material | Lens-color | Luminous Intensity (IF=10mA) mcd | | Wavelength nm λ P | Viewing Angle 2 θ 1/2 |
|-------------|----------------|-------------------|--------------|--|------|-------------------------|--------------------------|
| | | | | min. | typ. | | |
| XSUR62D | Red | GaAsP/GaP | Red Diffused | 5 | 7 | 627 | 120° |



❖ UR



Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85 degree°C.
- 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.No more than once.

Remarks:

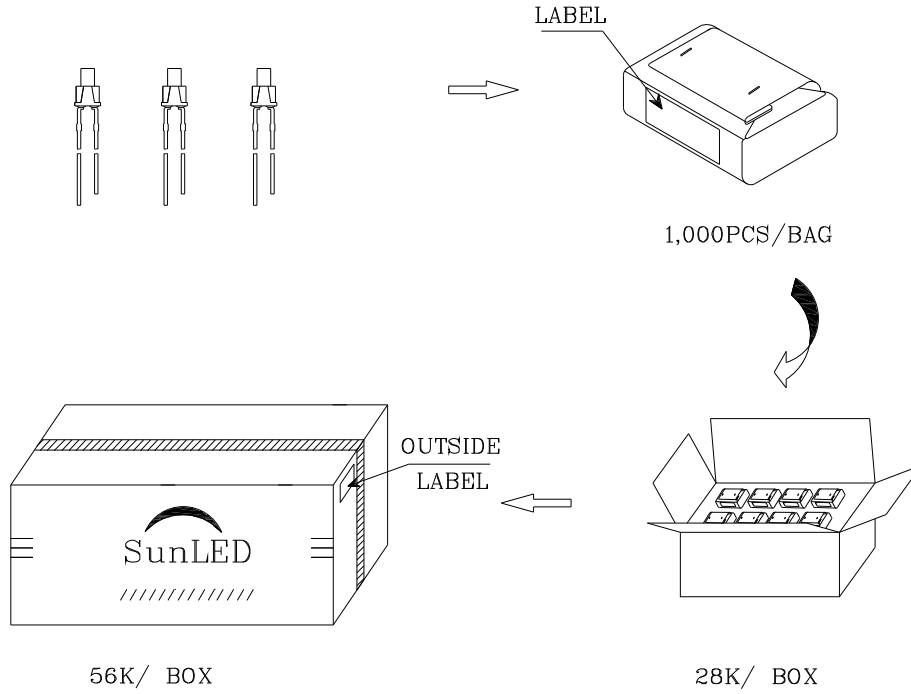
If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:


1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS

XSUR62D



| | |
|--|-----------|
| P/NO : XSxxx62x | |
| QTY : 1,000 pcs | CODE: XXX |
| S/N : XX | |
| LOT NO: | |
|  XXXXXXXXXXXXXXXXXXXX | |
| RoHS Compliant | |